

### NCE P-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE60P09S uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

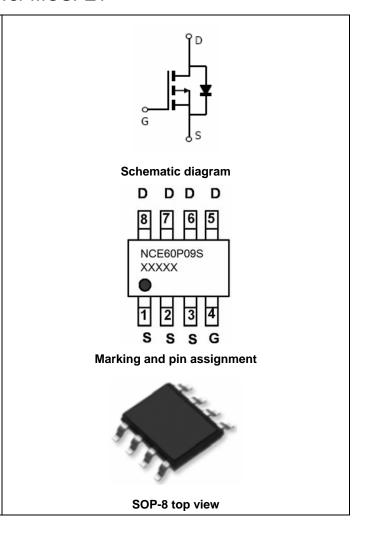
#### **General Features**

- V<sub>DS</sub> =-60V,I<sub>D</sub> =-9A
  - $R_{DS(ON)}$  <38m $\Omega$  @  $V_{GS}$ =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

#### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!



### **Package Marking and Ordering Information**

	J	J			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P09S	NCE60P09S	SOP-8	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	-9	Α
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	-6.4	Α
Pulsed Drain Current	I <sub>DM</sub>	36	Α
Maximum Power Dissipation	P <sub>D</sub>	3.0	W
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	156	mJ
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 150	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup> R <sub>0JA</sub> 41.7 °C/
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.8	-2.6	-3.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-9A	-	32	38	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-9A	-	20	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>Iss</sub>	V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V,	-	2049	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V, F=1.0MHz	-	112.7	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0ivinz	-	88.7	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	12	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-30 $V$ , $I_{D}$ =-9 $A$	-	14	-	nS
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS}$ =-10 $V$ , $R_{GEN}$ =3 $\Omega$	-	38	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	15	-	nS
Total Gate Charge	$Q_g$	V <sub>DS</sub> =-30V,I <sub>D</sub> =-9A,	-	35.1	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ 30V, $I_{D}$ 9A, $V_{GS}$ 10V	-	9	-	nC
Gate-Drain Charge	$Q_{gd}$	VGS10V	-	7.9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-9A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-9	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = -9A	-	-	40	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	-	70	nC

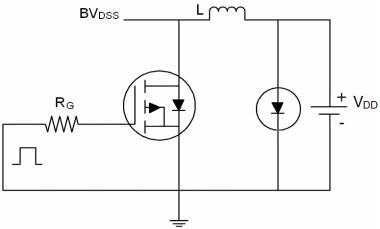
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- **4.** Guaranteed by design, not subject to production
- **5.** E<sub>AS</sub> condition: Tj=25  $^{\circ}\text{C}$  ,V<sub>DD</sub>=-30V,V<sub>G</sub>=-10V,L=0.5mH,Rg=25 $\Omega$

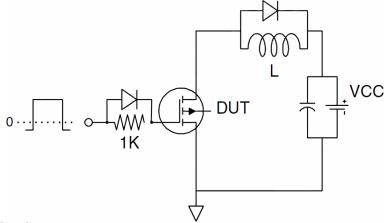


### **Test Circuit**

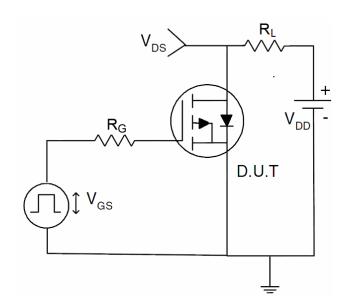
# 1) E<sub>AS</sub> Test Circuit



## 2) Gate Charge Test Circuit

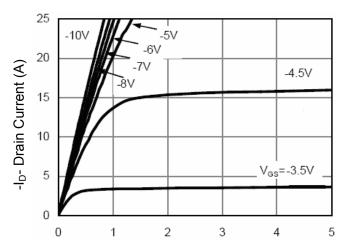


## 3) Switch Time Test Circuit



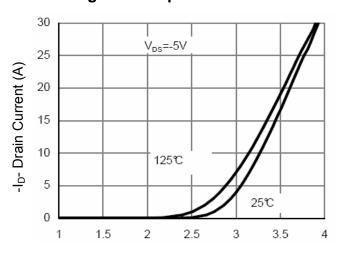


### **Typical Electrical and Thermal Characteristics (Curves)**



-Vds Drain-Source Voltage (V)

**Figure 1 Output Characteristics** 



-Vgs Gate-Source Voltage (V)

**Figure 2 Transfer Characteristics** 

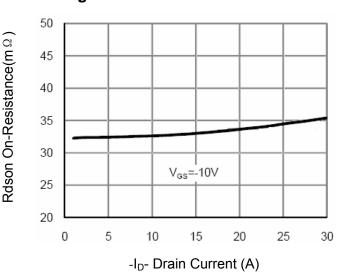
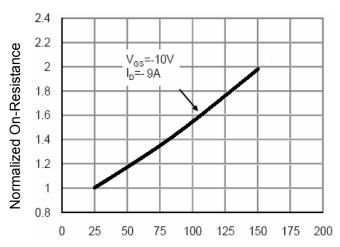
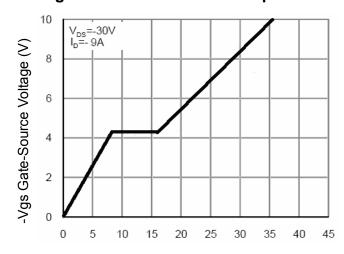


Figure 3 Rdson- Drain Current

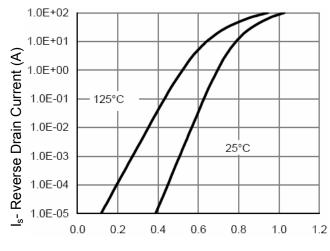


T<sub>J</sub>-Junction Temperature(°C)

Figure 4 Rdson-JunctionTemperature



Qg Gate Charge (nC)
Figure 5 Gate Charge



-Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



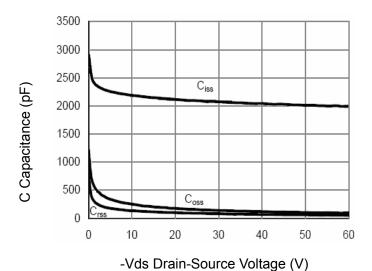
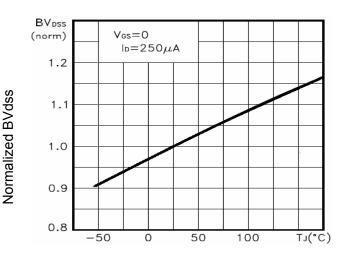
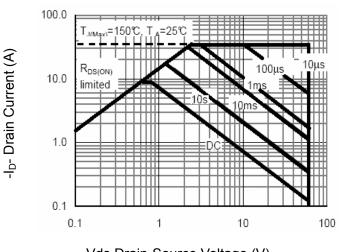


Figure 7 Capacitance vs Vds



 $T_J$ -Junction Temperature (°C) Figure 9 BV<sub>DSS</sub> vs Junction Temperature



-Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

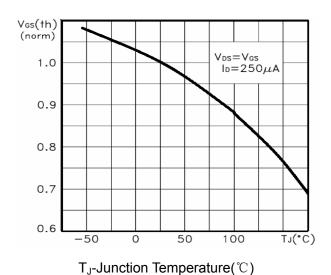
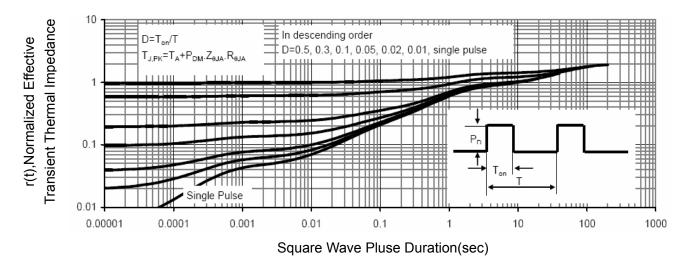


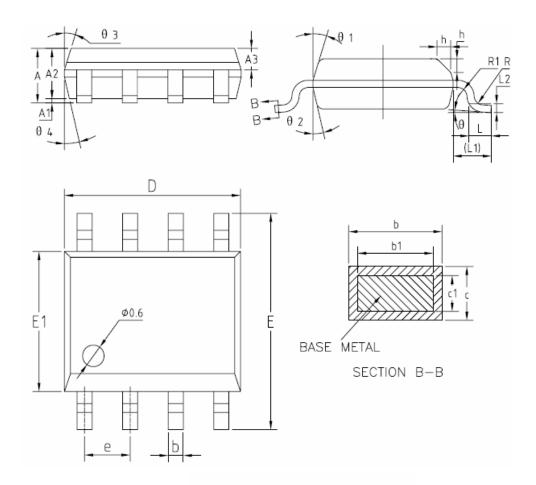
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **SOP-8 Package Information**



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
Α	1.35	1.55	1.75		
A1	0.10	0.15	0.25		
A2	1.25	1.40	1.65		
A3	0.50	0.60	0.70		
b	0.38	_	0.51		
b1	0.37	0.42	0.47		
С	0.18	_	0.25		
c1	0.17	0.20	0.23		
D	4.80	4.90	5.00		
E	5.80	6.00	6.20		
E1	3.80	3.90	4.00		
е	1.17	1.27	1.37		
L	0.45	0.60	0.80		
L L1		1.04REF			
L2		0.25BSC			
R	0.07	_	_		
R1	0.07	_	_		
h	0.30	0.40	0.50		
θ	0,	_	8*		
θ 1	15*	17*	19*		
θż	11*	13	15*		
θ3	15°	17'	19*		
θ 4	11"	13*	15"		





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